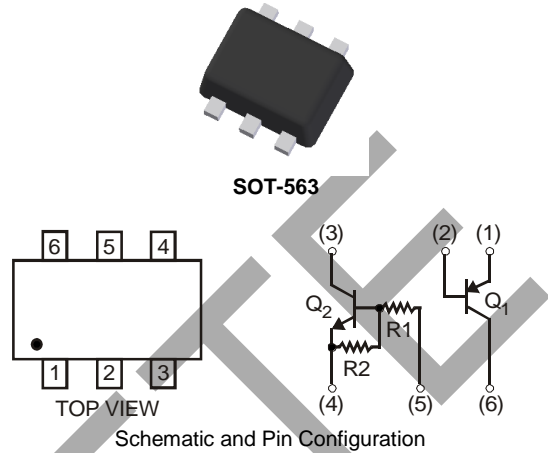


### Features

- Epitaxial Planar Die Construction
- One PNP Bipolar Transistor and One NPN Pre-Biased Transistor
- Ultra-Small Surface Mount Package
- **Lead Free By Design/RoHS Compliant (Note 1)**
- **"Green" Device (Note 2)**

### Mechanical Data

- Case: SOT-563
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminal Connections: See Diagram
- Terminals: Finish – Matte Tin Annealed Over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 4
- Ordering Information: See Page 4
- Weight: 0.003 grams (approximate)



### Maximum Ratings, Total Device @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3)	$P_D$	300	mW
Thermal Resistance, Junction to Ambient Air (Note 3)	$R_{\theta JA}$	417	$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150	$^\circ\text{C}$

### Maximum Ratings, PNP Transistor, $Q_1$ @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	$V_{CB0}$	-15	V
Collector-Emitter Voltage	$V_{CE0}$	-12	V
Emitter-Base Voltage	$V_{EB0}$	-6	V
Continuous Collector Current	$I_C$	-500	mA
Peak Pulsed Collector Current	$I_{CP}$	-1.0	A

### Maximum Ratings, Pre-Biased NPN Transistor, $Q_2$ @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Supply Voltage	$V_{CC}$	50	V
Input Voltage	$V_{IN}$	-10 to +40	V
Collector Current	$I_C$	100	mA
Output Current	$I_O$	50	mA

- Notes:
1. No purposefully added lead.
  2. Diodes Inc.'s "Green" policy can be found on our website at [http://www.diodes.com/products/lead\\_free/index.php](http://www.diodes.com/products/lead_free/index.php).
  3. Device mounted on FR-4 PCB; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.

OBSOLETE – PART DISCONTINUED

**Electrical Characteristics, PNP Transistor, Q<sub>1</sub> @T<sub>A</sub> = 25°C unless otherwise specified**

Characteristic (Note 4)	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	-15	—	—	V	I <sub>C</sub> = -10μA, I <sub>E</sub> = 0
Collector-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	-12	—	—	V	I <sub>C</sub> = -1.0mA, I <sub>B</sub> = 0
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	-6	—	—	V	I <sub>E</sub> = -10μA, I <sub>C</sub> = 0
Collector Cutoff Current	I <sub>CBO</sub>	—	—	-100	nA	V <sub>CB</sub> = -15V, I <sub>E</sub> = 0
Collector Cutoff Current	I <sub>EBO</sub>	—	—	-100	nA	V <sub>EB</sub> = -6V, I <sub>C</sub> = 0
DC Current Gain	h <sub>FE</sub>	270	—	680	—	V <sub>CE</sub> = -2.0V, I <sub>C</sub> = -10mA
Collector-Emitter Saturation Voltage	V <sub>CE(SAT)</sub>	—	-100	-250	mV	I <sub>C</sub> = -200mA, I <sub>B</sub> = -10mA
Gain-Bandwidth Product	f <sub>T</sub>	—	280	—	MHz	V <sub>CE</sub> = -2.0V, I <sub>E</sub> = 10mA, f = 100MHz
Collector Output Capacitance	C <sub>obo</sub>	—	5	—	pF	V <sub>CB</sub> = -10V, I <sub>E</sub> = 0, f = 1MHz

**Electrical Characteristics, Pre-Biased NPN Transistor, Q<sub>2</sub> @T<sub>A</sub> = 25°C unless otherwise specified**

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Input Voltage	V <sub>I(off)</sub>	—	—	0.5	V	V <sub>CC</sub> = 5V, I <sub>O</sub> = 100μA
	V <sub>I(on)</sub>	3	—	—	V	V <sub>O</sub> = 0.3V, I <sub>O</sub> = 10mA
Output Voltage	V <sub>O(on)</sub>	—	0.1	0.3	V	I <sub>O</sub> /I <sub>I</sub> = 10mA/0.5 mA
Input Current	I <sub>I</sub>	—	—	0.88	mA	V <sub>I</sub> = 5V
Output Current	I <sub>O(off)</sub>	—	—	0.5	μA	V <sub>CC</sub> = 50V, V <sub>I</sub> = 0V
DC Current Gain	G <sub>I</sub>	30	—	—	—	V <sub>O</sub> = 5V, I <sub>O</sub> = 5mA
Gain-Bandwidth Product (Note 5)	f <sub>T</sub>	—	250	—	MHz	V <sub>CE</sub> = 10V, I <sub>E</sub> = -5mA, f = 100MHz
Input Resistance	R <sub>1</sub>	7	10	13	kΩ	—
Resistance Ratio	R <sub>2</sub> /R <sub>1</sub>	0.8	1	1.2	—	—

- Notes:
- Short duration pulse test used to minimize self-heating effect.
  - Characteristics of the transistor. For reference only.

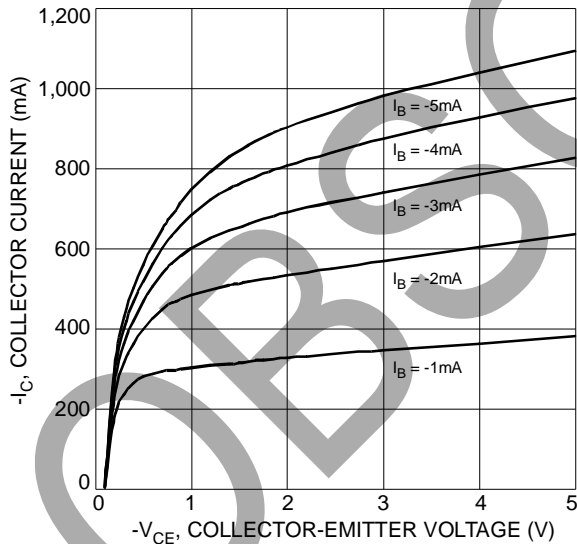


Fig. 1 Typical Collector Current vs. Collector-Emitter Voltage (Q<sub>1</sub>, PNP)

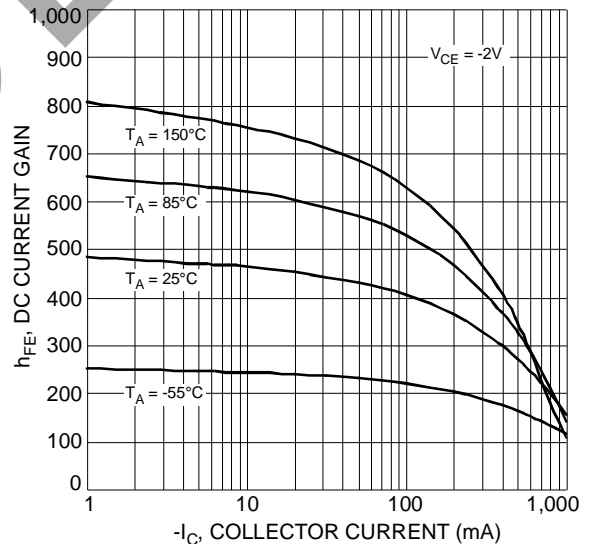


Fig. 2 Typical DC Current Gain vs. Collector Current (Q<sub>1</sub>, PNP)

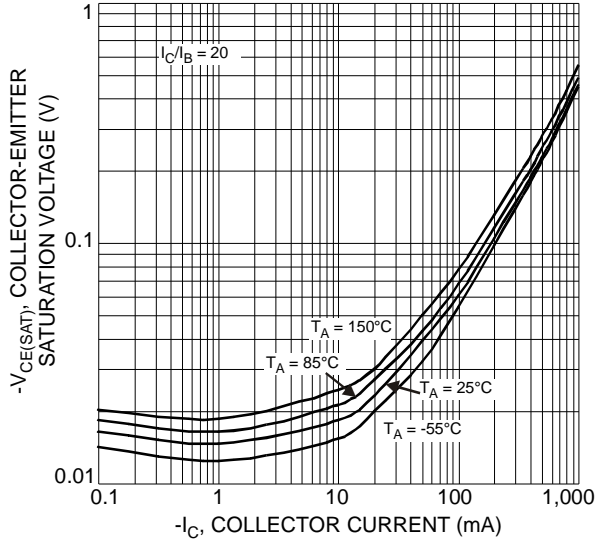


Fig. 3 Typical Collector-Emitter Saturation Voltage vs. Collector Current (Q1, PNP)

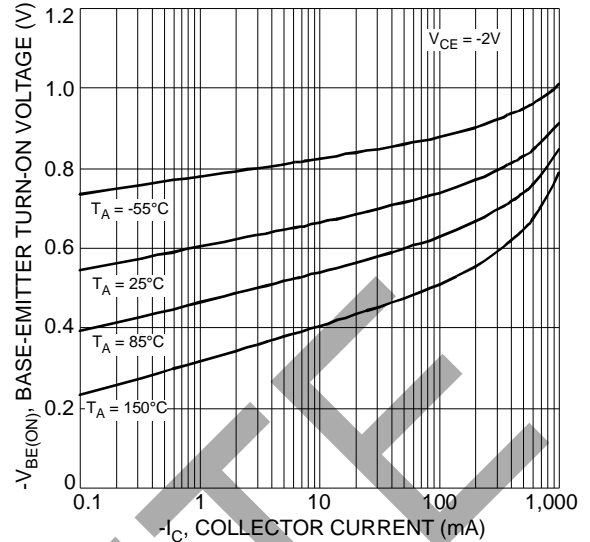


Fig. 4 Typical Base-Emitter Turn-On Voltage vs. Collector Current (Q1, PNP)

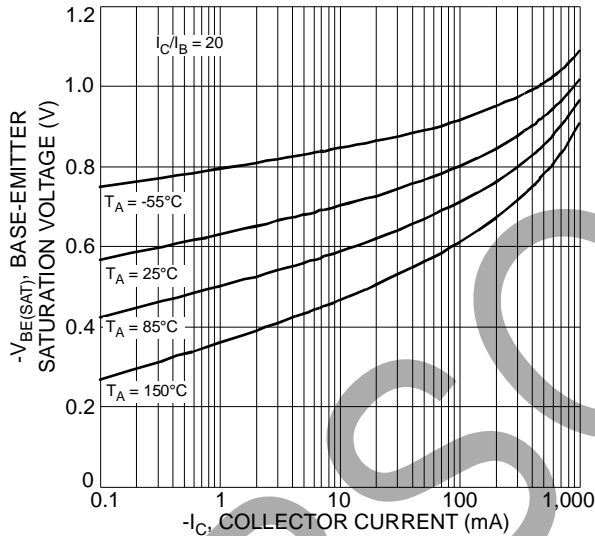


Fig. 5 Typical Base-Emitter Saturation Voltage vs. Collector Current (Q1, PNP)

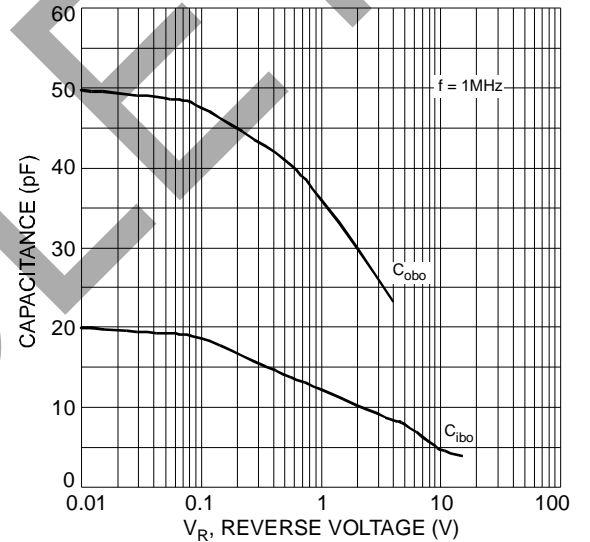


Fig. 6 Typical Capacitance Characteristics (Q1, PNP)

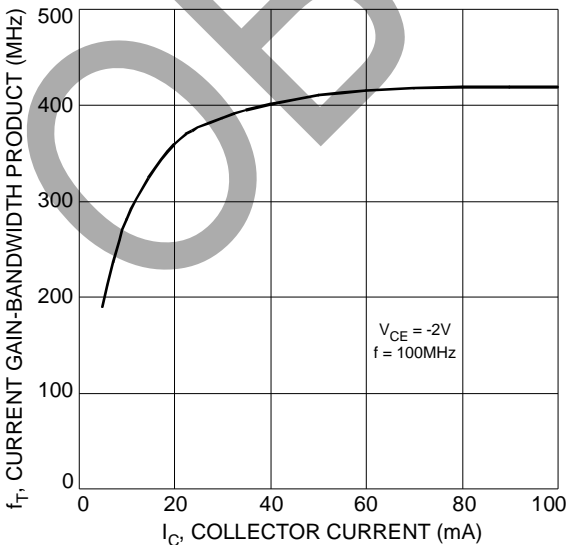


Fig. 7 Typical Gain-Bandwidth Product vs. Emitter Current (Q1, PNP)

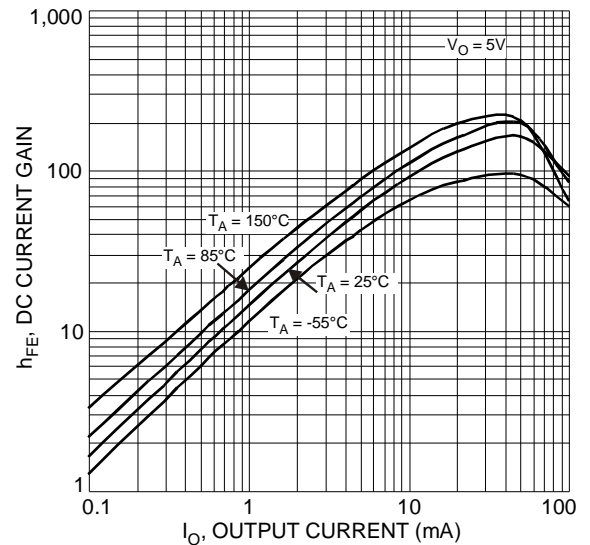


Fig. 8 Typical DC Current Gain vs. Output Current (Q2, NPN PBT)

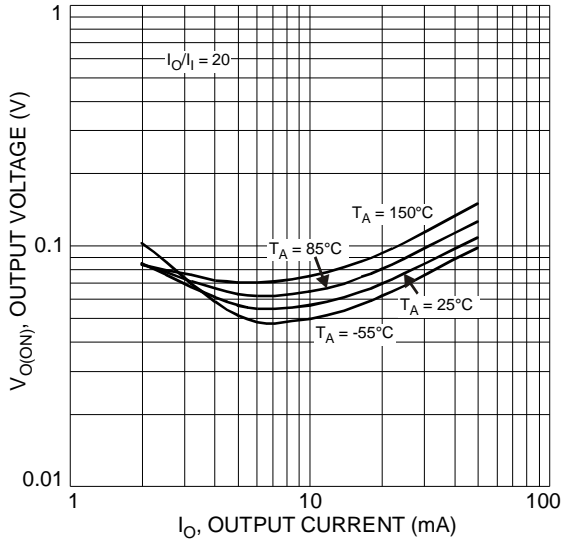


Fig. 9 Typical Output Voltage vs. Output Current (Q2, NPN PBT)

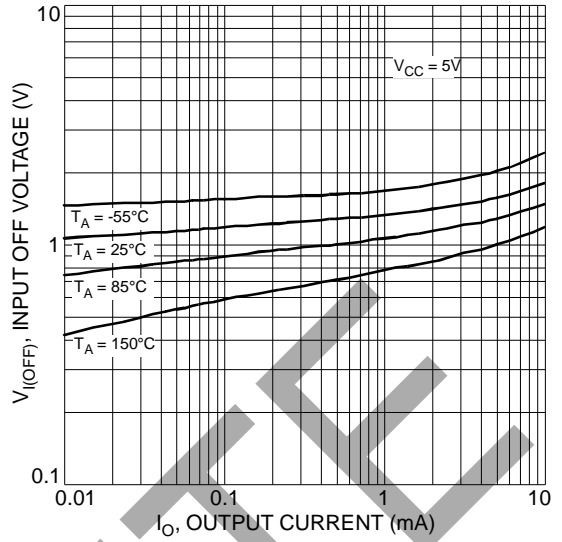


Fig. 10 Typical Input Off Voltage vs. Output Current (Q2, NPN PBT)

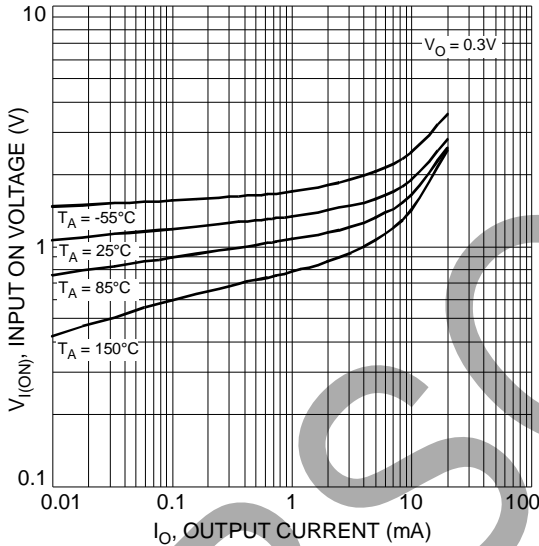


Fig. 11 Typical Input On Voltage vs. Output Current (Q2, NPN PBT)

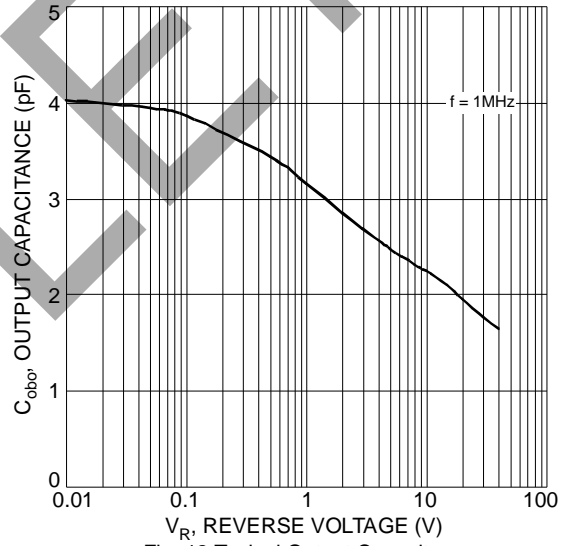


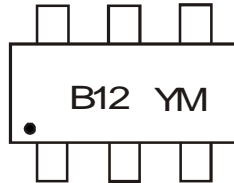
Fig. 12 Typical Output Capacitance Characteristics (Q2, NPN PBT)

## Ordering Information (Note 6)

Device	Packaging	Shipping
EMF21-7	SOT-563	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

## Marking Information



B12 = Product Type Marking Code  
 YM = Date Code Marking  
 Y = Year ex: U = 2007  
 M = Month ex: 9 = September

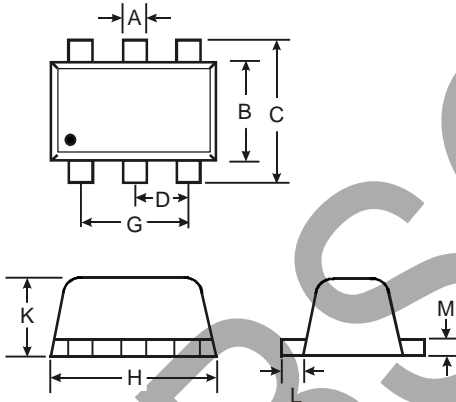
Date Code Key

Year Code	2007	2008	2009	2010	2011	2012
	U	V	W	X	Y	Z

Month Code	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
	1	2	3	4	5	6	7	8	9	O	N	D

## Package Outline Dimensions



SOT-563			
Dim	Min	Max	Typ
A	0.15	0.30	0.25
B	1.10	1.25	1.20
C	1.55	1.70	1.60
D	0.50	-	-
G	0.90	1.10	1.00
H	1.50	1.70	1.60
K	0.56	0.60	0.60
L	0.10	0.30	0.20
M	0.10	0.18	0.11
All Dimensions in mm			

**IMPORTANT NOTICE**

1. DIODES INCORPORATED (Diodes) AND ITS SUBSIDIARIES MAKE NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO ANY INFORMATION CONTAINED IN THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).
2. The Information contained herein is for informational purpose only and is provided only to illustrate the operation of Diodes' products described herein and application examples. Diodes does not assume any liability arising out of the application or use of this document or any product described herein. This document is intended for skilled and technically trained engineering customers and users who design with Diodes' products. Diodes' products may be used to facilitate safety-related applications; however, in all instances customers and users are responsible for (a) selecting the appropriate Diodes products for their applications, (b) evaluating the suitability of Diodes' products for their intended applications, (c) ensuring their applications, which incorporate Diodes' products, comply the applicable legal and regulatory requirements as well as safety and functional-safety related standards, and (d) ensuring they design with appropriate safeguards (including testing, validation, quality control techniques, redundancy, malfunction prevention, and appropriate treatment for aging degradation) to minimize the risks associated with their applications.
3. Diodes assumes no liability for any application-related information, support, assistance or feedback that may be provided by Diodes from time to time. Any customer or user of this document or products described herein will assume all risks and liabilities associated with such use, and will hold Diodes and all companies whose products are represented herein or on Diodes' websites, harmless against all damages and liabilities.
4. Products described herein may be covered by one or more United States, international or foreign patents and pending patent applications. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks and trademark applications. Diodes does not convey any license under any of its intellectual property rights or the rights of any third parties (including third parties whose products and services may be described in this document or on Diodes' website) under this document.
5. Diodes' products are provided subject to Diodes' Standard Terms and Conditions of Sale (<https://www.diodes.com/about/company/terms-and-conditions/terms-and-conditions-of-sales/>) or other applicable terms. This document does not alter or expand the applicable warranties provided by Diodes. Diodes does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.
6. Diodes' products and technology may not be used for or incorporated into any products or systems whose manufacture, use or sale is prohibited under any applicable laws and regulations. Should customers or users use Diodes' products in contravention of any applicable laws or regulations, or for any unintended or unauthorized application, customers and users will (a) be solely responsible for any damages, losses or penalties arising in connection therewith or as a result thereof, and (b) indemnify and hold Diodes and its representatives and agents harmless against any and all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim relating to any noncompliance with the applicable laws and regulations, as well as any unintended or unauthorized application.
7. While efforts have been made to ensure the information contained in this document is accurate, complete and current, it may contain technical inaccuracies, omissions and typographical errors. Diodes does not warrant that information contained in this document is error-free and Diodes is under no obligation to update or otherwise correct this information. Notwithstanding the foregoing, Diodes reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes.
8. Any unauthorized copying, modification, distribution, transmission, display or other use of this document (or any portion hereof) is prohibited. Diodes assumes no responsibility for any losses incurred by the customers or users or any third parties arising from any such unauthorized use.
9. This Notice may be periodically updated with the most recent version available at <https://www.diodes.com/about/company/terms-and-conditions/important-notice>

The Diodes logo is a registered trademark of Diodes Incorporated in the United States and other countries.  
All other trademarks are the property of their respective owners.  
© 2024 Diodes Incorporated. All Rights Reserved.

[www.diodes.com](http://www.diodes.com)